



# HT series

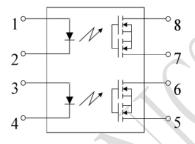
Photo Coupler Product Specification

HT8-21X



#### Package





Pin Configuration

1.3. AN

2.4. CA

5.6.7.8 Drain

## **■** Description

The HT8-21X is solid state relays containing two AlGaAs infrared LEDs on the light emitting side (input side) optically coupled to a high voltage output detector circuit. The detector consists of a photovoltaic diode array and MOSFETs on the output side. The single channel configuration is equivalent to 1 form A EMR. The devices in a 8-pin small outline SMD package.

#### **■** Features

- Normally open signal pole signal throw relay
- Low operating current
- 60 to 600V output withstand voltage
- Wide operating temperature range of -40°C to 85°C
- High input-output isolation voltage(Viso = 5,000Vrms)
- Safety approval (UL 1577, VDE DIN EN60747-5-5 (VDE 0884-5), CQC11-471543-2022)
- RoHS
- MSL1

#### Applications

- Measurement equipment
- Exchange equipment
- FA/OA equipment
- Security
- Industrial controls



#### **■ Product Nomenclature**

The product name is designated as below:

#### HT8 -21X -X X- X X- XX

1 2 3 4 5

#### Designation:

HT =Hengtuo Technology Co.,LTD.

8 = Dip 6 Package type

21X= Product Series(212,213,214,216)

- ① = Lead form option(S1,M,NONE)<sub>(1)</sub>
- 2 = Tape and Reel option(TP,TP1,NONE)<sub>(2)</sub>
- ③ = VDE order option(fixed code "V")
- 4 = Halogen free option(fixed code"G")
- ⑤ = Customer code

#### **Notes**

1. Lead form option:

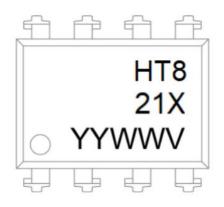
	III o o ii o ii
Symbol	Description
S1	DIP4-S1
М	DIP4-M
NONE	DIP4 Normal

2. Tape and Reel option:

Symbol	Description
TP&TP1	Tape and Reel Type
NONE	DIP Type



# ■ Marking Information



#### Designation:

HT denotes Hengtuo
8 denotes Dip 8 Package type
21X denotes Device
YY denotes year code
WW denotes week code
V denotes VDE

Maximum Ratings

	Parameter	Symbol	Valu	es	Unit
	Forward Current	l <sub>F</sub>	50		mA
	Reverse Voltage	VR	6	6	
	Power Dissipation	Р	75		MW
Input	Peak Forward Current (100µs pulse, 100Hz)	I <sub>FP</sub>	1		Α
	Thermal Resistance Junction-Ambient	R <sub>thJ-A</sub>	325	5	°C/W
	Thermal Resistance Junction-Case	R <sub>thJ-C</sub>	200	)	°C/W
			HT8-212	60	
	Break Down Voltage	$V_L$	HT8-213	100	V
			HT8-214	400	V
			HT8-216	600	
		ΙL	HT8-212	550	
Output	Continuous Load Current		HT8-213	180	ъ Л
Output	Continuous Load Current		HT8-214	120	mA
			HT8-216	50	
	,		HT8-212	1.2	
	Pulse Load Current*(1)		HT8-213	0.5	^
	Fulse Load Current	I <sub>LPeak</sub>	HT8-214	0.3	Α
			HT8-216	0.15	
Power Di	ssipation	P <sub>out</sub>	500	)	mW
Operating	g temperature range	T <sub>op</sub>	<b>–40 ∼</b>	85	°C



Storage temperature range	$T_{stg}$	<b>−</b> 40 ~ 125	°C
Total Power consumption	P(W)	550	mW
Isolation Voltage <sup>(2)</sup>	V <sub>ISO</sub>	5000	Vrms
Soldering Temperature <sup>(3)</sup>	$T_{SOL}$	260	°C

#### Notes:

(1).A connection: 100ms (1 shot), VL = DC

(2)AC for 1 minute, R.H.=  $40 \sim 60\%$  R.H. In this test, pins 1,4are shorted together, and pins 5, 8 are shorted together.

(3).For 10 seconds

# **■ Electronic Optical Characteristics**

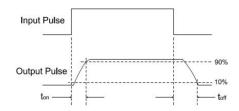
 $(TA = 25^{\circ}C)$ 

	Parai	mete	er	Symb ol	Min.	Тур.	Max.	Unit	Conditon	
Input	Forward	d Volta	age	VF	-	1.2	1.5	V	I <sub>F</sub> =10mA	
Imput	Reverse	e Curr	ent	IR	$\lambda$ -\	<b>)</b> -	1	μA	V <sub>R</sub> =5V	
	Off Stat Current		kage	I <sub>leak</sub>	-	-	1	μA	I <sub>F</sub> =0mA, V∟=Max	
			HT8-212		-	0.7	2.5			
	On	,	HT8-213		-	6.5	15	Ω	$I_F=10mA$ , $I_L=$	
	Resistan	nce	HT8-214	$-R_{d(ON)}$	-	20	30	72	Max. t = 1s	
Output	4		HT8-216		-	40	70	•		
		HI	HT8-212		-	80	-			
1	Output Capacit	Output		HT8-213		-	60	-	"F	VL = 0V, f =
4		ance	HT8-214	- C <sub>out</sub> -	-	45	-	- pF	1MHz	
			•	HT8-216	-	-	30	-		
Transfer Characteristics		LED Curre	turn on ent	IF <sub>(on)</sub>		2.5	5	mA	IL = Max.	
		LED curre	turn off nt	IF <sub>(off)</sub>	0.4	2.5	-	mA	IL = Max.	
Turn O	a Tima	Н	T8-212	т	_	1.4	1.4 3	<b>D</b>	IF = 10 mA, IL = Max. RL	
Turn Oı	i iime	me HT8-213		- T <sub>ON</sub> -	-	1.2	3	ms	$= 200 \Omega,$	



HENGIOUEL	LECTRONICS					
	HT8-214	_	-	0.4	3	_
	HT8-216		-	1.4	3	
Turn Off Time	HT8-212	_	_	0.05	0.5	
	HT8-213	T <sub>OFF</sub> -	-	0.05	0.5	
	HT8-214	- I OFF	-	0.05	0.5	
	HT8-216	-	-	0.05	0.5	

Turn on/Turn off Time





#### **■** Characteristics Curves

Fig.1 LED Dropout Voltage vs. Ambient Temperature

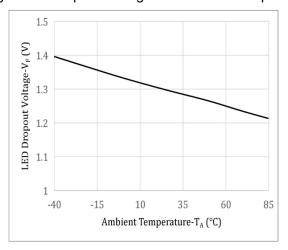


Fig.3 On Resistance vs. Ambient

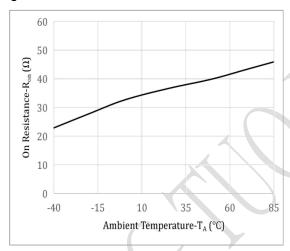


Fig.5 LED Operate Current vs. Ambient Temperature

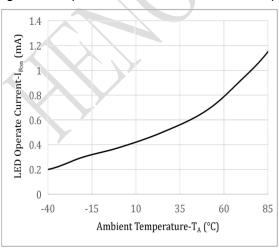


Fig.2 Output Current vs. Output Voltage

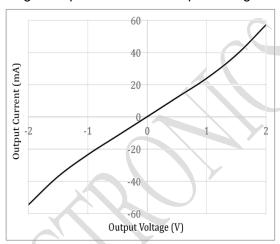


Fig.4 Load Current vs. Ambient Temperature

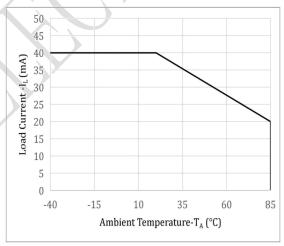


Fig.6 LED Turn Off Current vs. Ambient

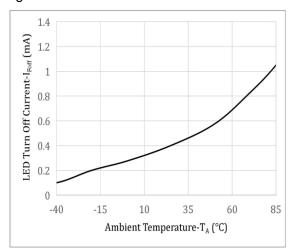




Fig.7 Turn On Time vs. Ambient Temperature

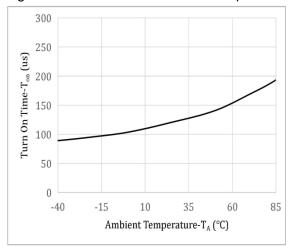


Fig.9 Turn On Time vs. LED Forward Current

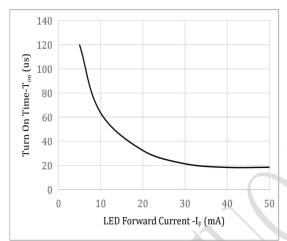


Fig.11 Off State Leakage Current vs Load Voltage

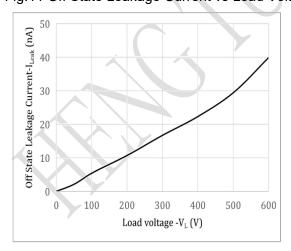


Fig.8 Turn Off Time vs. Ambient Temperature

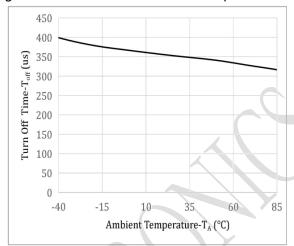
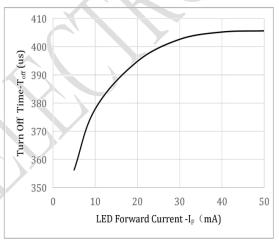


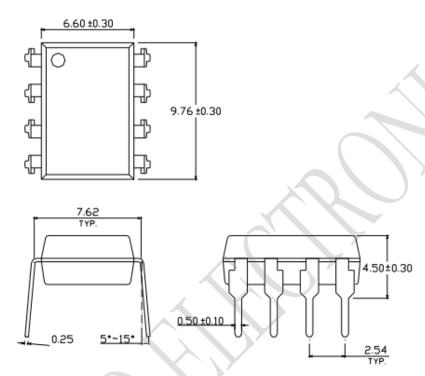
Fig.10 Turn Off Time vs. LED Forward



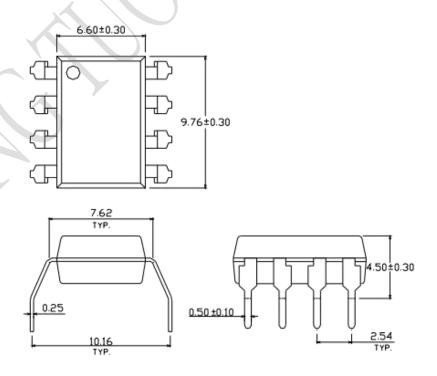


## **■** Outline Dimension

## DIP Normal Type:

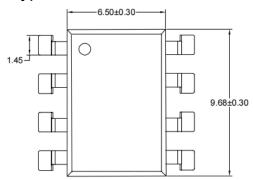


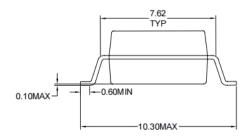
## DIP M Type:

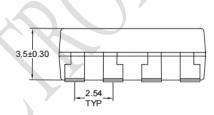




#### SMD S1 Type:





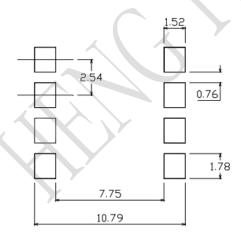


Unit: mm

Tolerance: ±0.1mm

# ■ Recommended solder pad Design

For S1 type:



Unit: mm

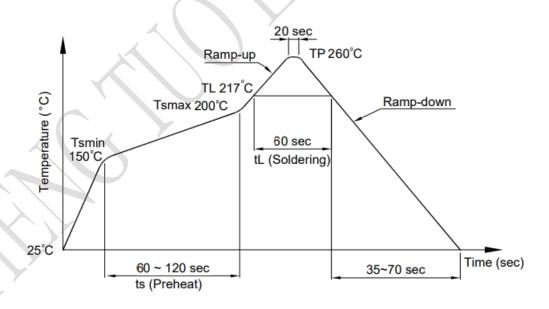
Tolerance: ±0.1mm



## **■ Temperature Profile Of Soldering**

# 1. IR Reflow soldering (JEDEC-STD-020 compliant)

Profile item	Conditon
Preheat -Temperature Min (TSmin) -Temperature Max (TSmax) -Time (min to max) (ts)	150°C 200°C 90±30 sec
Soldering zone -Temperature (TL) -Time (tL)	217°C 60 sec
Peak Temperature (TP)	260°C
Ramp-up rate	3°C / sec max
Ramp-down rate	3~6°C/ sec

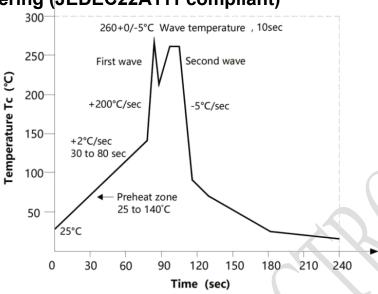


#### Notes:

One time soldering reflow is recommended within the condition of temperature and time profile shown below. Do not solder more than three times.



## 2. Wave soldering (JEDEC22A111 compliant)



#### 3. Hand soldering by soldering iron

Allow single lead soldering in every single process. One time soldering is recommended.

Temperature: 380+0/-5°C

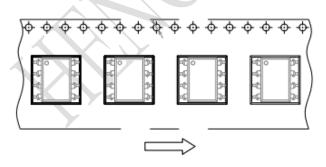
Time: 3 sec max.

## ■ Packing

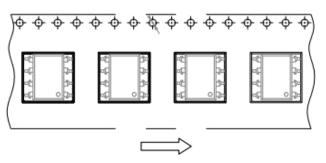
#### 1. Tape and Reel

**Option TA:** 

**Option TA1:** 

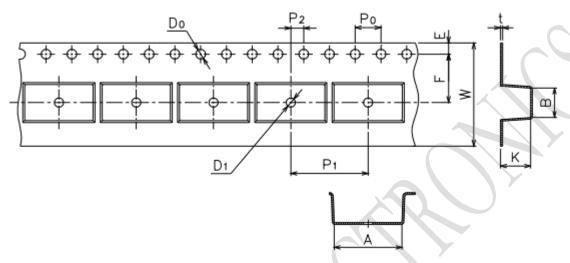


Direction of feed from reel



Direction of feed from reel





Deminsion/mm	Α	В	Do	D1	E	F
Packagetype:S	10.4±0.1	10.0±0.1	1.5+0.1/-0	1.5±0.25/-0	1.75±0.1	7.5±0.1

Deminsion/mm	Ро	P1	P2	t	W	K
Packagetype:S	4.0±0.1	12.0±0.1	2.0±0.05	0.4±0.05	16.0±0.3/	4.5±0.1

# 2. Tape and Tube

Package type:Normal&M	Tube	Outer carton
QTY/PCS	45	2.25K(50 tubes)



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